

Proposed Changes to SPI

- **Annex A.3 and A.4 Change**

- d) The SCSI device being removed or inserted shall employ transceivers that conform to the requirements for glitch-free power on/off in 7.1.2 and 7.2.2. The SCSI device shall maintain the high-impedance state at the device connector contacts during a power cycle until the transceiver is enabled. Power Cycling includes on board Tempwr cycling, caused by plugging, and device power cycling caused by plugging or switching. Note that any on board switchable terminators as well as device transceivers may affect the impedance state at the device connector contacts.

- **Annex A.4 Addition Limit Tempwr Bypassing**

- g) Bypassing capacitors connecting to the Tempwr line on the device being inserted or removed shall not exceed 10 uF. For single-ended applications, bus termination shall use voltage regulation on both ends (Reference SCSI-2 Alternative 2).

Voh Issue

- **7.1.2 Voh allows 5.25V Maximum, Add Note 8**
 - Note 8 With these specifications voltages greater than 3.24 can not be directly driven by the driver, but voltages above 3.24 may occur as reflections.
- **7.1.1 Single-ended Termination, Add f**
 - f) The terminator shall not source current above 3.24 V d.c.